

REPLACEMENT SHEET  
"LAYERED SUPPORT AND METHOD FOR LAMINATING CMP PADS"

Inventors: Ichiro Kodaka, et al.

Application No. 10/754,381

Sheet 2 of 7

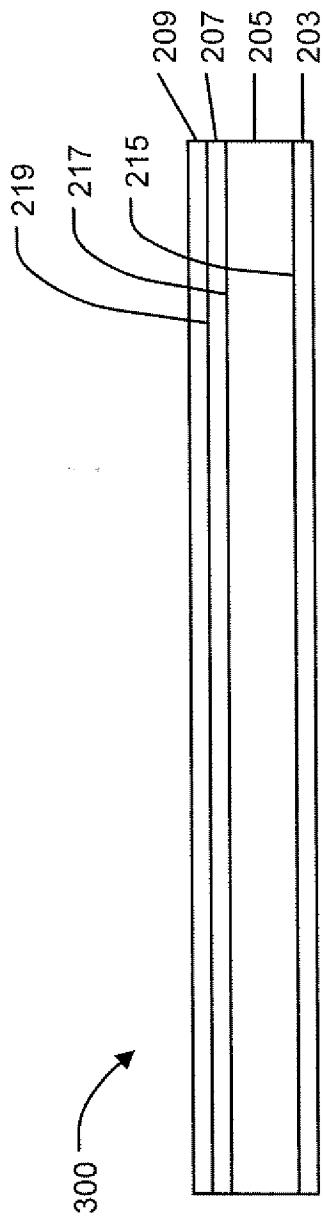


FIG. 3A

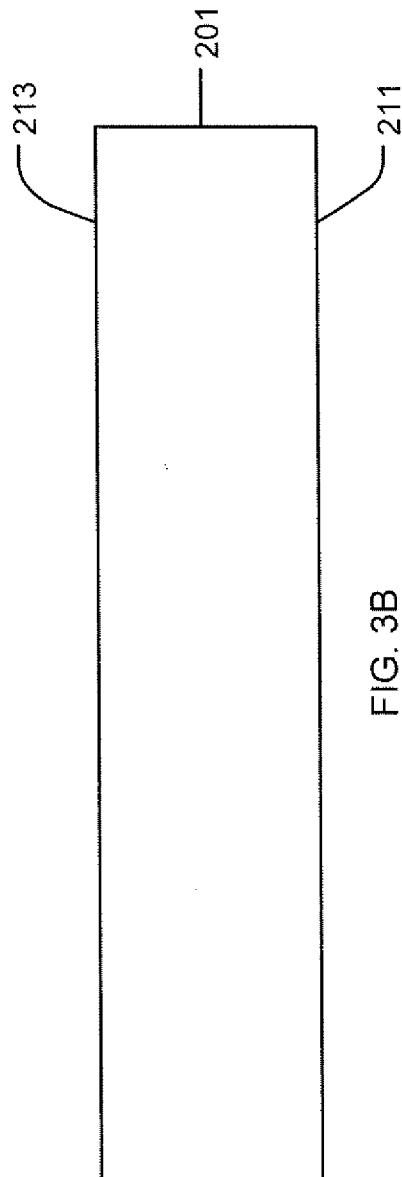


FIG. 3B

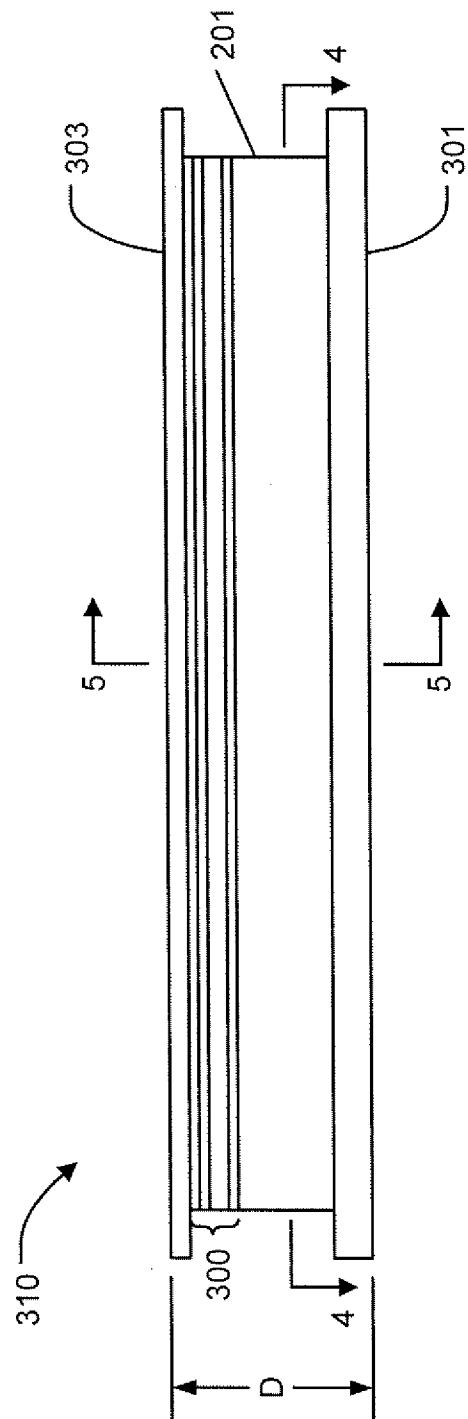


FIG. 3C